



1 Creation Road 3,
Hsinchu Science Park,
Hsinchu 30077, Taiwan, R.O.C.

Customer Declaration of Compliance - OEM

We declared that under our sole responsibility which is our green products and components for customer comply with the regulations as below list and be willing to provide all necessary documentation or information to prove our compliance with the regulations.

It is our responsibility to proactively inform our customer, if we identify that there is a potential risk of breaching the regulations in our products and components.

Product Material: Solder, Flux, Solvent, Ink, Marking Pen and other indirect materials.

1. Product Information:

Accton Model P/N: FP3ZZ5654002A

Accton Description: ??SWITCH ES5654BQ-1115-168ZZ(5912-54X-O-AC-B), 1 N

Customer Products P/N: 5912-54X-O-AC-B

2. Classification:

- Full compliance with RoHS 2.0(2011/65/EU&EN50581:2012)(Pb,Hg,Cr6+,PBB,PBDE<1000ppm : Cd<100ppm)
- Partial compliance with RoHS 2.0(2011/65/EU&EN50581:2012)(except Pb)(Hg,Cr6+,PBB,PBDE<1000ppm : Cd<100ppm)
- Full compliance with RoHS 2.0(2011/65/EU&EN50581:2012)+PFOS(2006/122/EC)+PFOS(Pb,Hg,Cr6+,PBB,PBDE,PFOS<1000ppm : Cd<100ppm)
- Full compliance with China RoHS requirements (Pb,Hg,Cr6+,PBB,PBDE<1000ppm : Cd<100ppm)
- Full compliance Korea RoHS requirements (Pb,Hg,Cr6+,PBB,PBDE<1000ppm : Cd<100ppm)
- Full compliance with REACH (EC 1907/2006)
- Full compliance with Taiwan RoHS-CNS 15663 requirements
- Others

RoHS 6/6 :

Meet RoHS 2(2011/65/EU) and use RoHS Exemption as below :

6c : Copper alloy containing up to 4 % lead by weight .

7a : Lead in high melting temperature type solders (i.e. lead- based alloys containing 85 % by weight or more lead) .

7c-I : Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound.

ChinaRoHS:

产品内含有害物质揭露表 Products contain hazardous substances exposing table						
零部件名称 Component Name	有害物质项目 Hazardous Substances Project					
	铅 (Pb)	镉 (Cd)	汞 (Hg)	六价铬 (Cr6+)	多溴联苯 (PBB)	多溴二苯乙醚 (PBDE)
固态硬盘模块 SSD Module	X	○	○	○	○	○
动态随机存取内存模块 SDRAM Module	X	○	○	○	○	○
风扇 Fan	X	○	○	○	○	○
无线连接器 RF Connector	X	○	○	○	○	○
组合线 Cable ASS'Y	X	○	○	○	○	○
螺帽 Nut	X	○	○	○	○	○
螺丝 Scerw	X	○	○	○	○	○
环保电源供应器 BOX P/S	X	○	○	○	○	○
电阻 Resistor	X	○	○	○	○	○
集成电路组件 TTL/SMD	X	○	○	○	○	○
本表格依据 SJ/T : 11364-2014 的规定编制。						
○ : 表示此部件使用的所有同类材料中此种有毒或有害物质的含量均低于 GB/T 26572-2011 规定的限制要求。 ○ : indicates the toxic or hazardous substance content of the part (at the homogenous material level) is lower than the threshold defined by Requirements for Concentration Limits for Toxic or hazardous Substances in Electronic Information Products(GB/T 26572-2011) issued by Chinese Ministry of Information Industry ("Not Contained" toxic or hazardous substances).						
X:表示此部件使用的至少一种同类材料中，此种有毒或有害物质的含量高于 GB/T 26572-2011 规定的限制要求。 X: indicates the toxic or hazardous substance content of the part (at the homogenous material level) is over the threshold defined by standard of GB/T 26572-2011("Contained" toxic or hazardous substances). Suppliers can explain the technical cause of "X" according to actual situation.						

REACH:

Meet REACH 173 SVHCs (Directive EC 1907/2006) and REACH SVHC material list follow ECHA web announce.
<http://echa.europa.eu/web/guest/candidate-list-table>

Company : Accton Technology Corporation

Responsible person in charge : RUBY CHEN

Signature : 

Date : 2017/06/30

保存期限十年

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